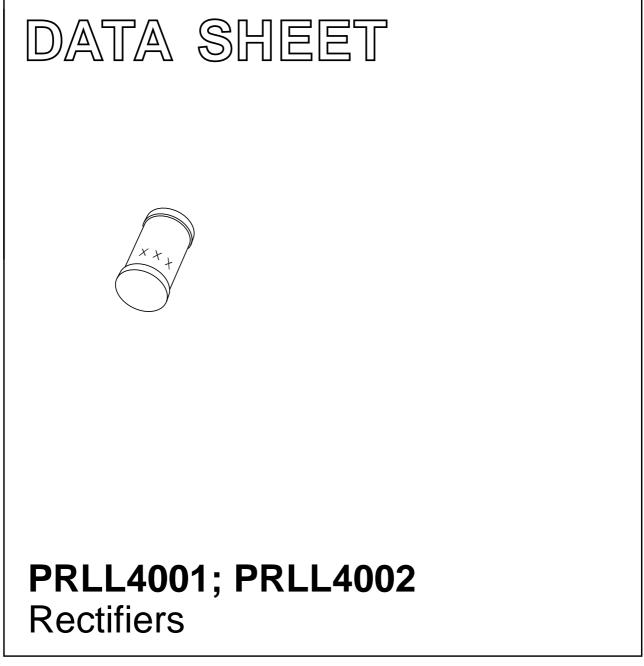
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1996 Jun 10 2003 May 13



HILIP

FEATURES

- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Shipped in 8 mm embossed tape
- Smallest surface mount rectifier outline.

DESCRIPTION

Cavity free cylindrical glass package through Implotec^{{\rm TM}(1)} technology.

(1) Implotec is a trademark of Philips.

PRLL4001; PRLL4002

This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

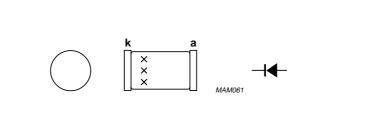


Fig.1 Simplified outline (SOD87) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	repetitive peak reverse voltage				
	PRLL4001		-	50	V
	PRLL4002		-	100	V
V _R	continuous reverse voltage				
	PRLL4001		-	50	V
	PRLL4002		-	100	V
I _{F(AV)}	average forward current	averaged over any 20 ms period; $T_{tp} = 105 \text{ °C}$	-	1.60	A
		averaged over any 20 ms period; T _{amb} = 65 °C; see Fig.2	-	0.68	A
I _{FRM}	repetitive peak forward current		-	10	A
I _{FSM}	non-repetitive peak forward current	half sinewave; 60 Hz	-	20	A
T _{stg}	storage temperature		-65	+175	°C
Tj	junction temperature		-65	+175	°C

PRLL4001; PRLL4002

ELECTRICAL CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V _F	forward voltage	I _F = 1 A; see Fig.3	1.1	V
V _{F(AV)}	full-cycle average forward voltage	$I_{F(AV)} = 1 A$	0.8	V
I _R	reverse current	$V_{R} = V_{Rmax}$	10	μA
		$V_R = V_{Rmax}; T_{amb} = 100 \ ^\circ C$	50	μA
I _{R(AV)}	full-cycle average reverse current	$V_R = V_{RRMmax}; T_{amb} = 75 \ ^{\circ}C$	30	μA

THERMAL CHARACTERISTICS

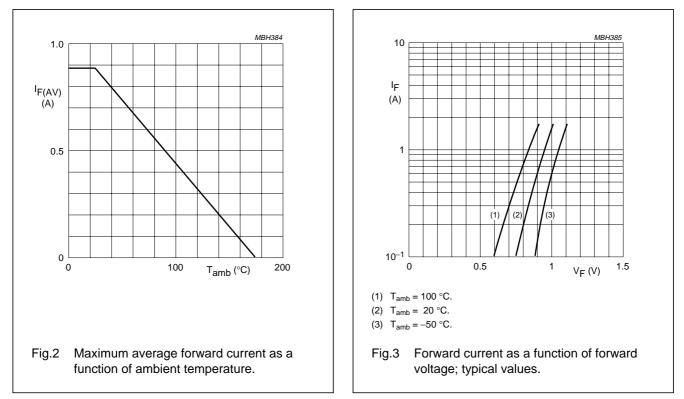
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point		30	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	150	K/W

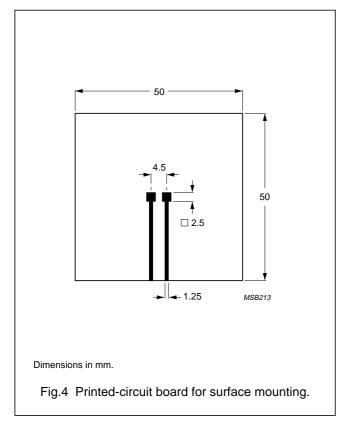
Note

1. Device mounted on epoxy-glass printed-circuit board, 1.5 mm thick; thickness of copper \ge 40 µm, see Fig.4. For more information please refer to the *"General Part of associated Handbook"*.

PRLL4001; PRLL4002

GRAPHICAL DATA



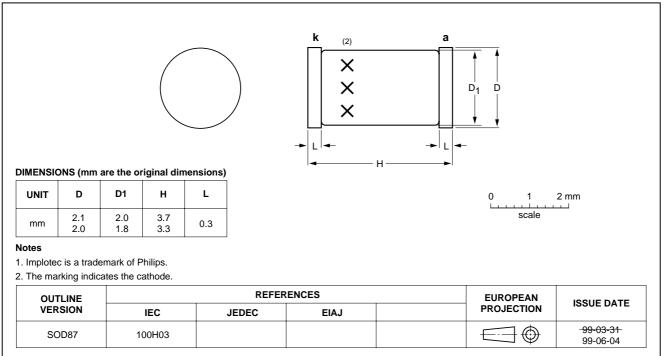


SOD87

PRLL4001; PRLL4002

PACKAGE OUTLINE

Hermetically sealed glass surface mounted package; Implotec^{TM(1)} technology; 2 connectors



PRLL4001; PRLL4002

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Product specification

Rectifiers

PRLL4001; PRLL4002

NOTES

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